

HSF

NOTES:

Current Rating:5.0A AMP
Contact Resistance:10milliohm Max
Withstand Voltage:1000V AC/Minute
Insulation Resistance:1000Megohm Min
Operation Temperature:-25℃ to +85℃

Housing Material:LCP+30%GF(UL94V-0)
Contact Material:Copper alloy
Contact plating:Au/Sn over Ni Plating

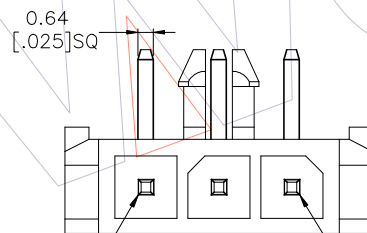
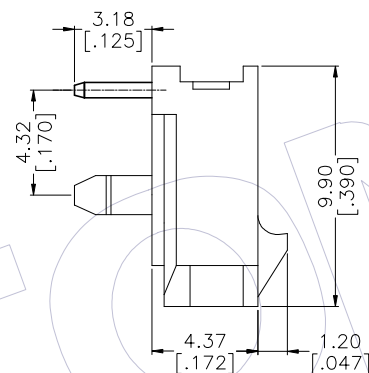
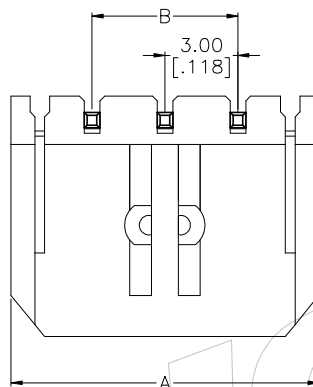
Ordering Information

WF3001-1 WR XX B X 1

Terminal shape:
WR:Wafer 90°DIP

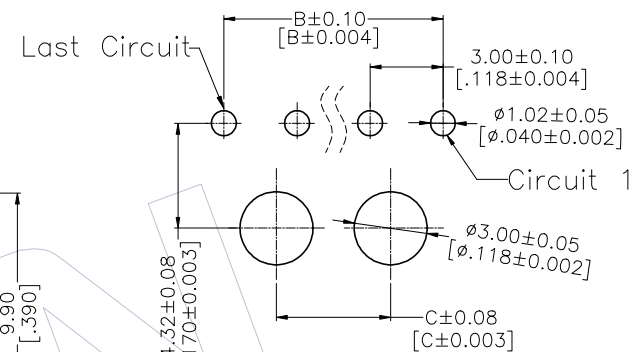
NO.of Pins
02~12Pin

Packing:
0=PE Bag
T=Tube
A=Tray
R=Tape&Reel

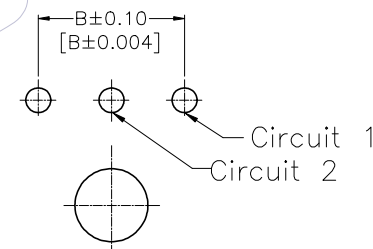


Circuit 1 Last Circuit

RECOMMENDED PCB LAYOUT TOLERANCE IS ±0.05



4-12 Circuit PCB LAYOUT



2-3 Circuit PCB LAYOUT

Circuit	A	B	C
02	9.65[0.380]	3.00[0.118]	NA
03	12.65[0.498]	6.00[0.236]	NA
04	15.65[0.616]	9.00[0.355]	4.70[0.185]
05	18.65[0.735]	12.00[0.473]	7.70[0.303]
06	21.65[0.853]	15.00[0.591]	10.70[0.421]
07	24.65[0.971]	18.00[0.709]	13.70[0.539]
08	27.65[1.089]	21.00[0.827]	16.70[0.657]
09	30.65[1.207]	24.00[0.945]	19.70[0.776]
10	33.65[1.325]	27.00[1.063]	22.70[0.894]
11	36.65[1.443]	30.00[1.181]	25.70[1.012]
12	39.65[1.561]	33.00[1.299]	28.70[1.130]

REV	DATE	MODIFICATION DESCRIPTION	CHANGE	OPERATION		DRAW FZY	DATE 2012.05.02	SCALE 1:1	PART NO. WF3001-1WRXXBX1
				X.X	±0.40				
A1	2012.05.03	料号由WF3001-1WRHXXBX1变更为WF3001-1WRXXBX1	Atomy	X.XX	±0.25	CHECK	DATE	UNIT mm inch	TITLE: 3.0 Wafer Single Row 90°DIP With Post
A0	2011.12.20	NEW	-	X.XXX	±0.15	APPROVE	DATE	SIZE A4	
				Angle	± 3'			SHEET 1/1	Customer NO.
				DIM	TOL			PROJ.	

WCON

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